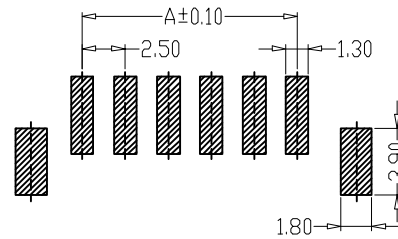
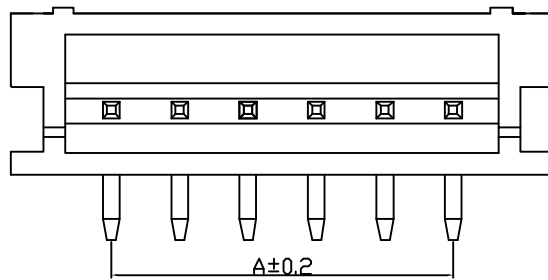
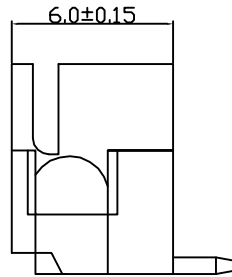
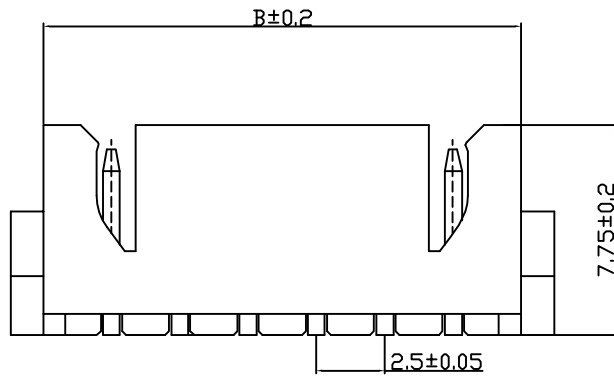


Wafer

Positions : 2~15 Circuits
 Insulator : LCP
 Contact : Brass
 Plated : Tin-plated 50u" Min
 Color : White/Black

SPECIFICATIONS

Current Rating : 3AMP
 Temperature Range : -40° C to +105° C
 Contact Resistance : 20mΩ Max
 Insulation Resistance : 1000MΩ Min
 Withstanding Voltage : AC 1000V



PCB LAYOUT

Dimension: $A = (\text{Pos} - 1) * 2.50$
 $B = A + 5.00$

XYFW(www.cnxyfw.com)

未注公差	X: ± 0.35 X.X: ± 0.25 X.XX: ± 0.20 X.XXX: ± 0.15	品名规格	XH2.5 Wafer 立式 SMT			
		客户品号				
Size: A4	UNIT: mm	版本	制图	审核	核准	日期
Scale: 1:1	☉ □	A/0	易红	王笑		2008-9-9